

$V_{RM} = 600\text{ V}$ ,  $I_{F(AV)} = 60\text{ A}$ ,  $t_{rr} = 70\text{ ns}$   
Fast Recovery Diode  
**FMXR-4606S-SP**

**Description**

The FMXR-4606S-SP is a fast recovery diode of 600 V / 60 A. The low  $Q_{rr}$  characteristic allows the product to have almost no ringing at turn-off, leading to the realization of low-noise systems. The maximum  $t_{rr}$  of 70 ns is realized by optimizing a life-time control.

**Features**

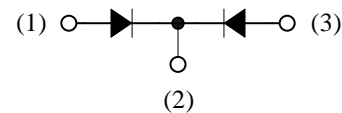
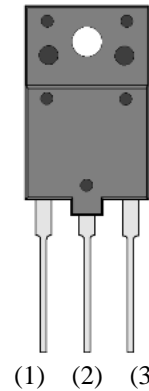
- $V_{RM}$ ----- 600 V
- $I_{F(AV)}$ ----- 60 A
- $V_F$ ----- 2.5 V
- $t_{rr}$ ----- 70 ns
- $Q_{rr}$ ----- 170 nC
- Bare lead frame: Pb-free (RoHS compliant)

**Applications**

- CCM PFC Circuit
- Secondary Side Rectifier Diode
- Boost Diode

**Package**

TO3PF-3L



(1) Anode  
(2) Cathode  
(3) Anode

Not to scale

## FMXR-4606S-SP

### Absolute Maximum Ratings

Unless otherwise specified,  $T_A = 25\text{ }^\circ\text{C}$

Parameter	Symbol	Rating	Unit	Conditions
Peak Repetitive Reverse Voltage	$V_{RSM}$	600	V	
Repetitive Reverse Voltage	$V_{RM}$	600	V	
Average Forward Current	$I_{F(AV)}$	60	A	See Figure 3 and Figure 4
Surge Forward Current	$I_{FSM}$	120	A	Half cycle sine wave, positive side, 10 ms, 1 shot
$I^2t$ Limiting Value	$I^2t$	72	$\text{A}^2\text{s}$	$1\text{ ms} \leq t \leq 10\text{ ms}$
Junction Temperature	$T_J$	-40 to 150	$^\circ\text{C}$	
Storage Temperature	$T_{STG}$	-40 to 150	$^\circ\text{C}$	

### Electrical Characteristics

Unless otherwise specified,  $T_A = 25\text{ }^\circ\text{C}$

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Forward Voltage Drop <sup>(1)</sup>	$V_F$	$T_J = 25\text{ }^\circ\text{C}$ , $I_F = 30\text{ A}$	—	—	2.5	V
		$T_J = 100\text{ }^\circ\text{C}$ , $I_F = 30\text{ A}$	—	2.2	—	V
Reverse Leakage Current <sup>(1)</sup>	$I_R$	$V_R = V_{RM}$	—	—	10	$\mu\text{A}$
Reverse Leakage Current Under High Temperature <sup>(1)</sup>	$H \cdot I_R$	$V_R = V_{RM}$ , $T_J = 150\text{ }^\circ\text{C}$	—	—	1.5	mA
Reverse Recovery Time <sup>(1)</sup>	$t_{rr}$	$I_F = 30\text{ A}$ , $V_R = 400\text{ V}$ , $di/dt = -200\text{ A}/\mu\text{s}$ , 100% recovery point	—	—	70	ns
Reverse Recovery Charge <sup>(1)</sup>	$Q_{rr}$	$I_F = 30\text{ A}$ , $V_R = 400\text{ V}$ , $di/dt = -200\text{ A}/\mu\text{s}$ , 100% recovery point	—	—	170	nC
Thermal Resistance	$R_{th(J-F)}$	<sup>(2)</sup>	—	—	0.9	$^\circ\text{C}/\text{W}$
	$R_{th(J-L)}$	<sup>(3)</sup>	—	—	1.2	$^\circ\text{C}/\text{W}$

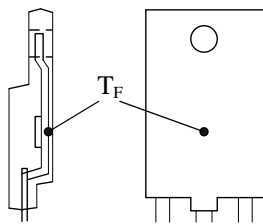


Figure 1.  $T_F$  Measurement Point

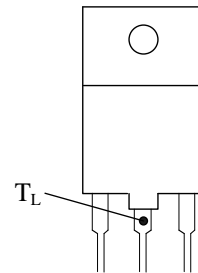


Figure 2.  $T_L$  Measurement Point

<sup>(1)</sup> The rating of one chip.

<sup>(2)</sup>  $R_{th(J-F)}$  is thermal resistance between junction and the flame.  $T_F$  is the flame temperature ( $^\circ\text{C}$ ), measured at the point defined in Figure 1.

<sup>(3)</sup>  $R_{th(J-L)}$  is thermal resistance between junction and the lead.  $T_L$  is the cathode lead temperature ( $^\circ\text{C}$ ), measured at the point defined in Figure 2.

Rating and Characteristic Curves

$T_F$  is the flame temperature (°C), measured at the point defined in Figure 1.

$T_L$  is the cathode lead temperature (°C), measured at the point defined in Figure 2.

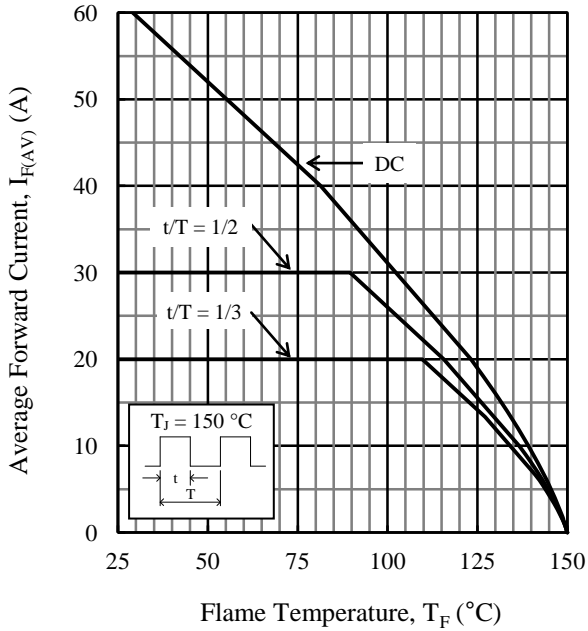


Figure 3.  $I_{F(AV)}$  vs.  $T_F$  Typical Characteristics ( $V_F = 0$  V)

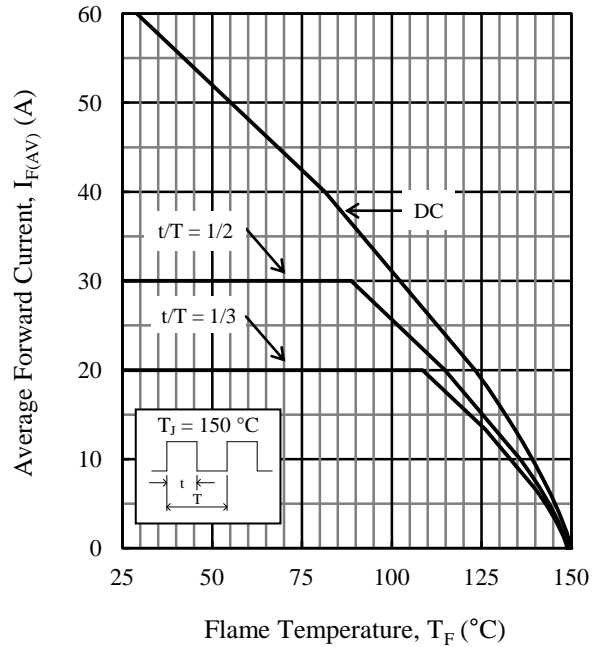


Figure 4.  $I_{F(AV)}$  vs.  $T_F$  Typical Characteristics ( $V_R = 600$  V)

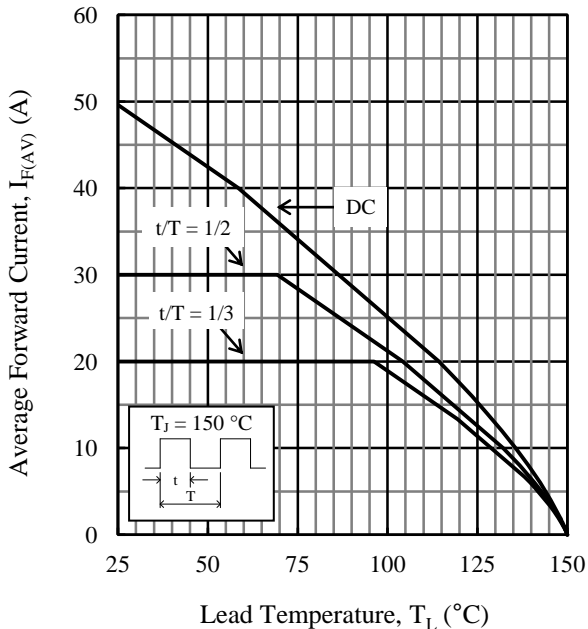


Figure 5.  $I_{F(AV)}$  vs.  $T_L$  Typical Characteristics ( $V_R = 0$  V)

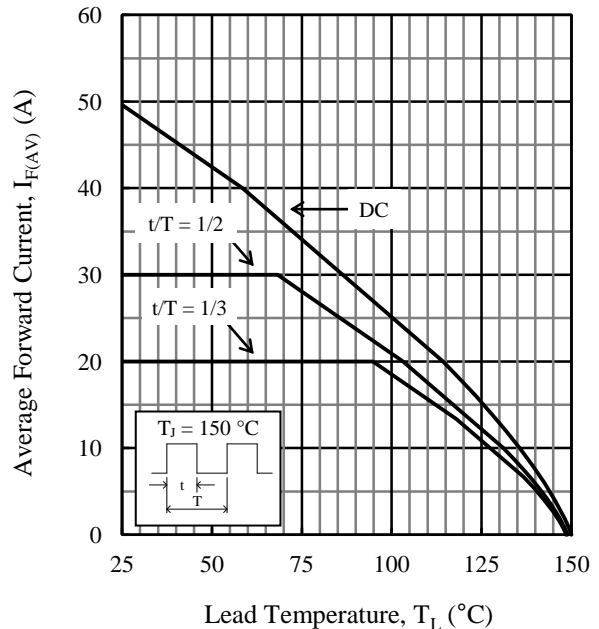


Figure 6.  $I_{F(AV)}$  vs.  $T_L$  Typical Characteristics ( $V_R = 600$  V)

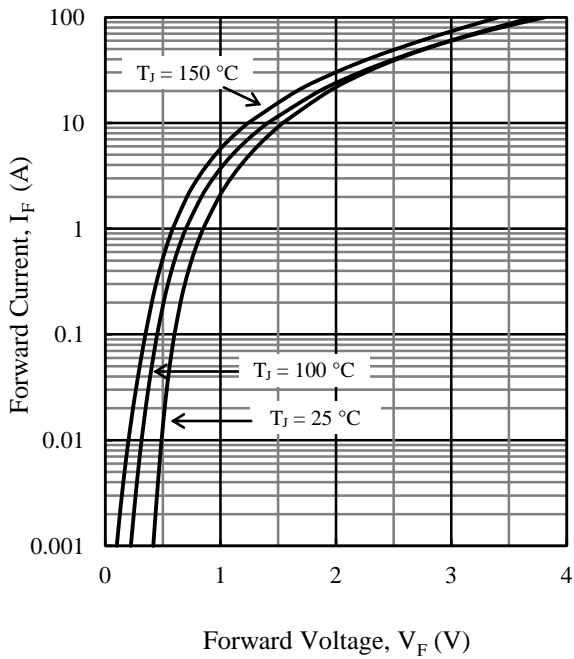


Figure 7.  $V_F$  vs.  $I_F$  Typical Characteristics

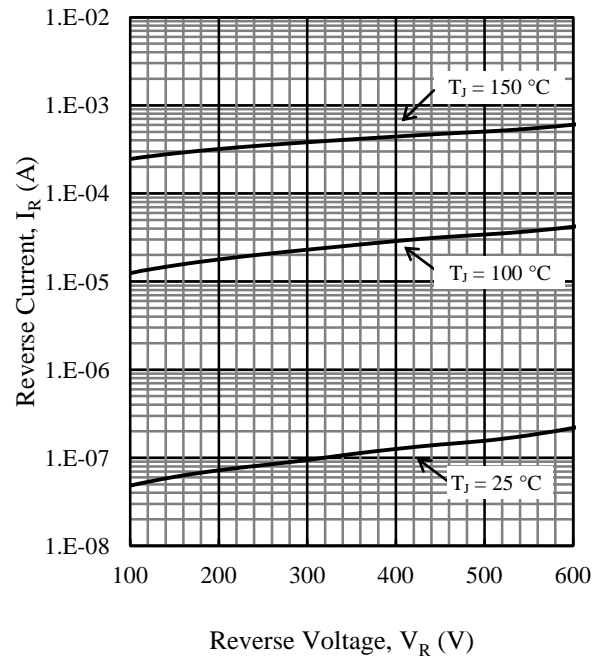


Figure 8.  $V_R$  vs.  $I_R$  Typical Characteristics

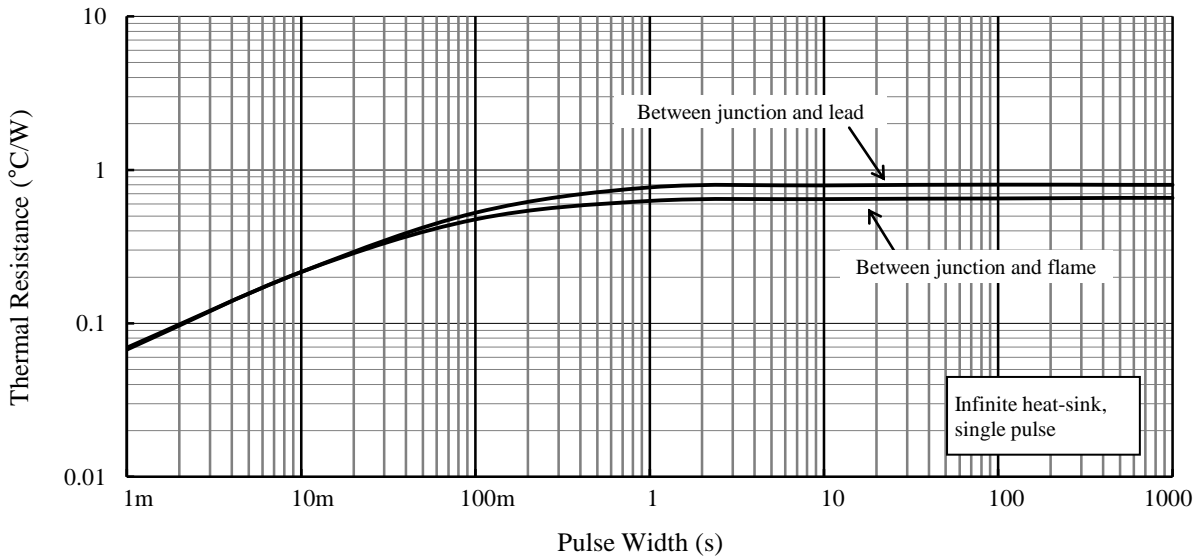
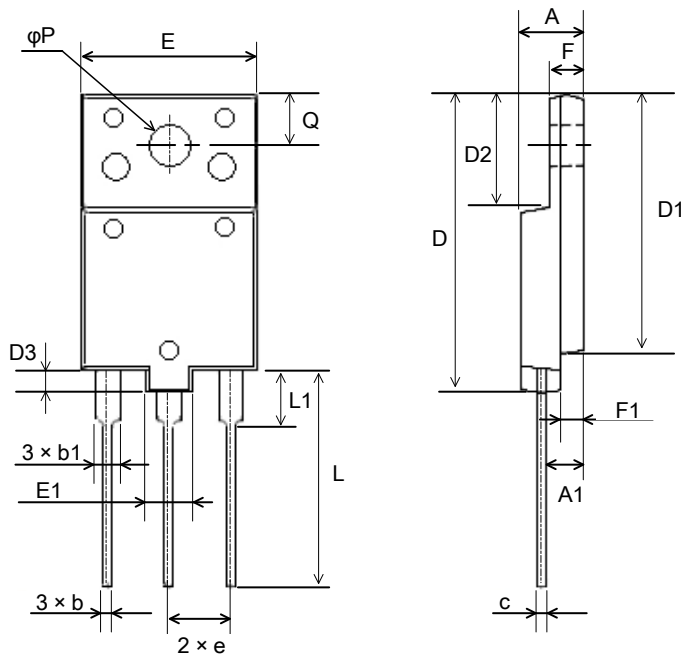


Figure 9. Typical Transient Thermal Resistance

# FMXR-4606S-SP

## Physical Dimensions

### • TO3PF-3L



Symbol	Min.	Nom.	Max.
A	5.30	5.50	5.70
A1	3.10	3.30	3.50
b	0.65	0.75	0.95
b1	1.80	2.00	2.20
c	0.80	0.90	1.10
D	26.30	26.50	26.70
D1	22.80	23.00	23.20
D2	9.80	10.00	10.20
D3	1.80	2.00	2.20
E	15.30	15.50	15.70
E1	3.80	4.00	4.20
e	5.25	5.45	5.65
F	2.80	3.00	3.20
F1	1.80	2.00	2.20
L	19.10	19.30	19.50
L1	4.80	5.00	5.20
Q	4.30	4.50	4.70
$\phi P$	3.40	3.60	3.80

### NOTES:

- Dimensions in millimeters
- Bare lead frame: Pb-free (RoHS compliant)
- When soldering the products, it is required to minimize the working time, within the following limits:
  - Flow:  $260 \pm 5 \text{ }^\circ\text{C} / 10 \pm 1 \text{ s}$ , 2 times
  - Soldering Iron:  $380 \pm 10 \text{ }^\circ\text{C} / 3.5 \pm 0.5 \text{ s}$ , 1 time
  - Soldering should be at a distance of at least 1.5 mm from the body of the product.
- Recommended screw torque for TO3PF: 0.686 N·m to 0.882 N·m (7 kgf·cm to 9 kgf·cm)

### Marking Diagram

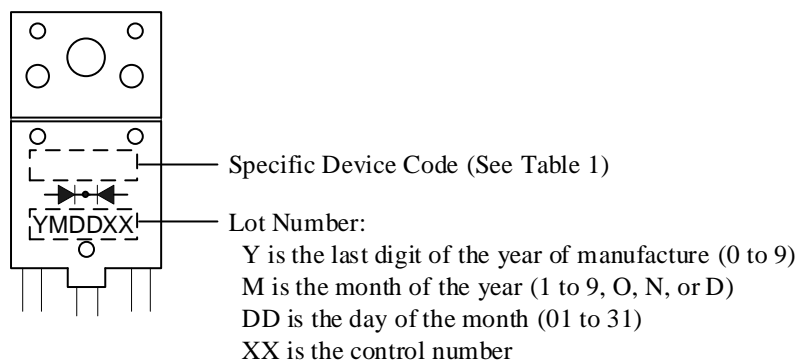


Table 1. Specific Device Code

Specific Device Code	Part Number
XR4606	FMXR-4606S-SP

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